March 2013

FDB088N08

N-Channel PowerTrench® MOSFET

75 V, 85 A, 8.8 mΩ

Features

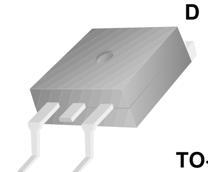
- $R_{DS(on)}$ = 7.3 mΩ (Typ.)@ V_{GS} = 10 V, I_D = 75 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- 100% Internal R_g Screening for Easy Paralleling Operation
- RoHS Compliant

Description

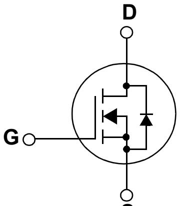
This N-Channel MOSFET is produced using Fairchild Semiconductor®'s adcanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies



TO-263
(D^2-PAK)



Absolute Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter		FDB088N08	Unit
V_{DSS}	Drain to Source Voltage		75	V
V_{GSS}	Gate to Source Voltage		±20	V
I_D	Drain Current	- Continuous (T_C = 25°C, Silicon Limited)	85*	A
		- Continuous (T_C = 100°C, Silicon Limited)	60	A
		- Continuous (T_C = 25°C, Package Limited)	120	A
I_{DM}	Drain Current	- Pulsed (Note 1)	340	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	309	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	10	V/ns
P_D	Power Dissipation	(T_C = 25°C)	160	W
		- Derate above 25°C	1.06	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C

*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

Thermal Characteristics

Symbol	Parameter	FDB088N08	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.94	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	
	Thermal Resistance, Junction to Ambient (1 in^2 pad of 2 oz copper), Max.	40	

Package Marking and Ordering Information T_C = 25°C unless otherwise noted

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB088N08	FDB088N08	D^2-PAK	330mm	24mm	800

Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V, T_C = 25°C	75	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250μA, Referenced to 25°C	-	0.07	-	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 75V, V_{GS} = 0V	-	-	1	μA
		V_{DS} = 75V, T_C = 150°C	-	-	500	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	2.0	-	4.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10V, I_D = 75A	-	7.3	8.8	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 10V, I_D = 37.5A	-	300	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V f = 1MHz	-	4960	6595	pF
C_{oss}	Output Capacitance		-	355	470	pF
C_{rss}	Reverse Transfer Capacitance		-	200	300	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 60V, I_D = 75A V_{GS} = 10V (Note 4)	-	91	118	nC
Q_{gs}	Gate to Source Gate Charge		-	22	-	nC
Q_{gd}	Gate to Drain “Miller” Charge		-	28	-	nC
R_G	Gate Resistance	f = 1MHz	-	-	4	Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 37.5V, I_D = 75A R_{GEN} = 25Ω, V_{GS} = 10V (Note 4)	-	45	100	ns
t_r	Turn-On Rise Time		-	158	326	ns
$t_{d(off)}$	Turn-Off Delay Time		-	244	498	ns
t_f	Turn-Off Fall Time		-	102	214	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	85	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	340	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_{SD} = 75A	-	-	1.25	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_{SD} = 75A dI_F/dt = 100A/μs	-	41.1	-	ns
Q_{rr}	Reverse Recovery Charge		-	80.7	-	nC

Notes:
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L = 0.11mH, I_{AS} = 75A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. I_{SD} ≤ 75A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

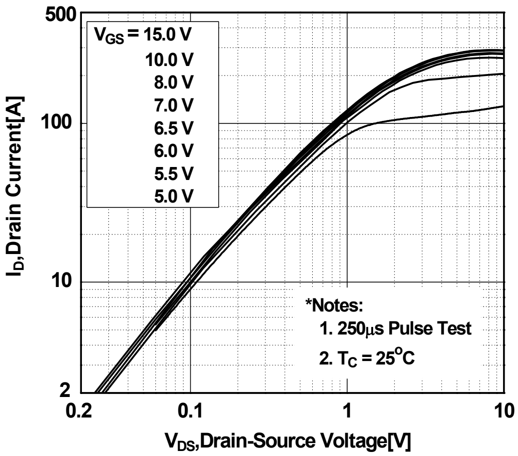


Figure 2. Transfer Characteristics

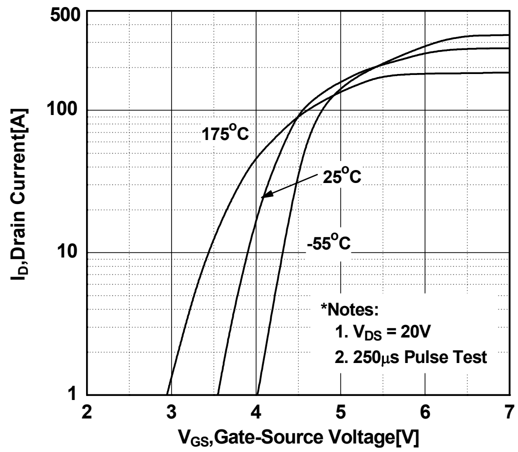


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

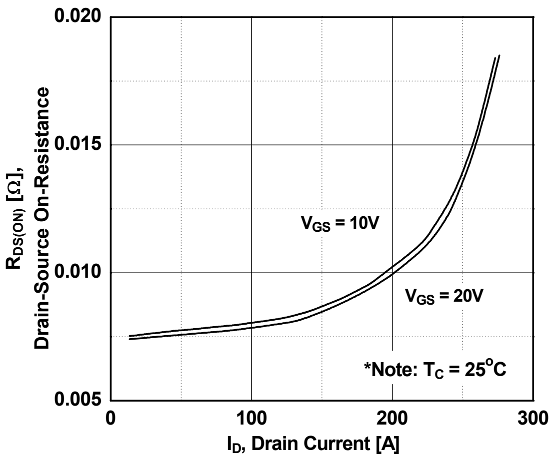


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

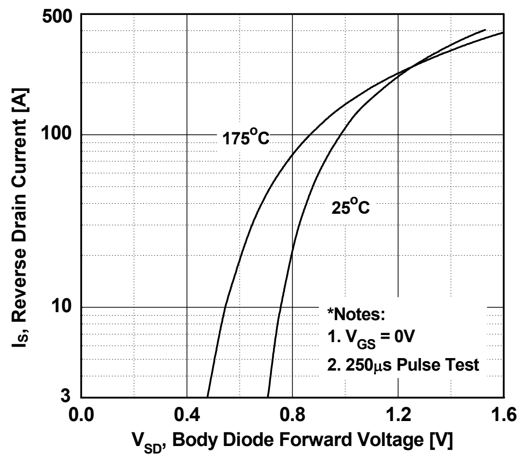


Figure 5. Capacitance Characteristics

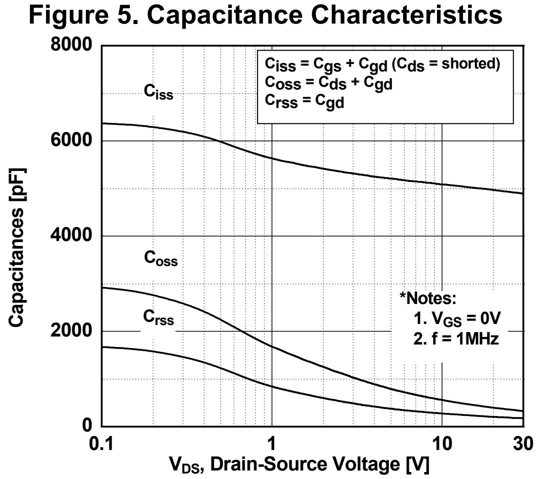
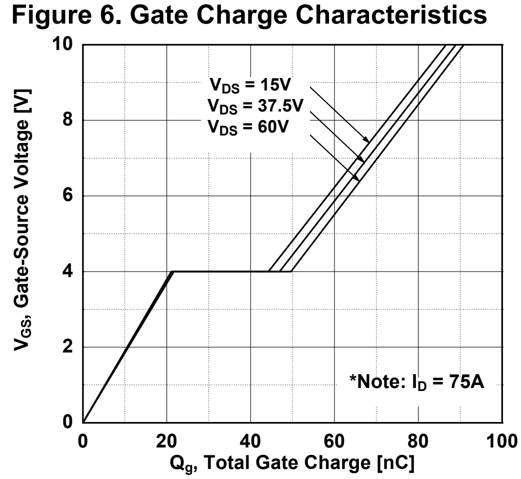


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

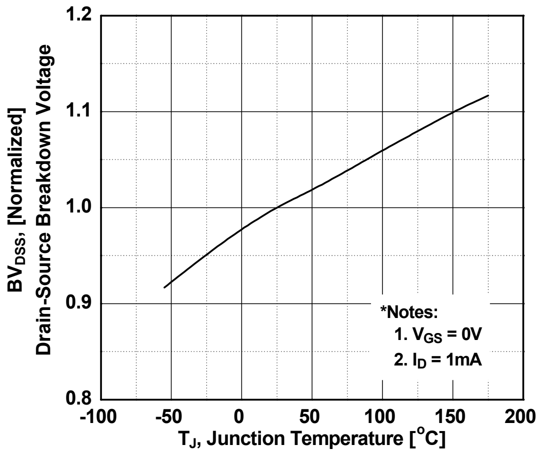


Figure 8. On-Resistance Variation vs. Temperature

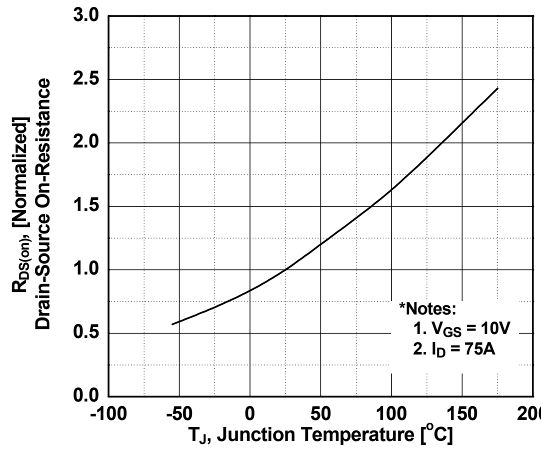


Figure 9. Maximum Safe Operating Area

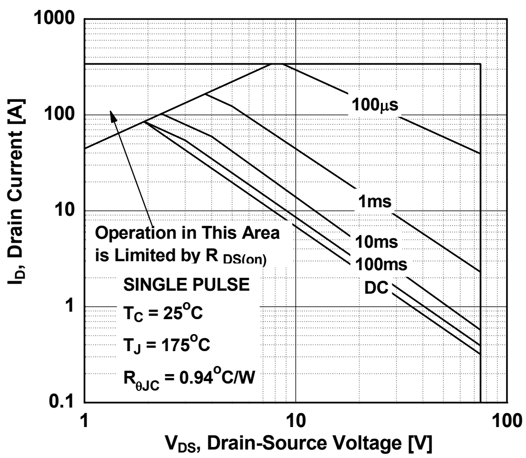


Figure 10. Maximum Drain Current vs. Case Temperature

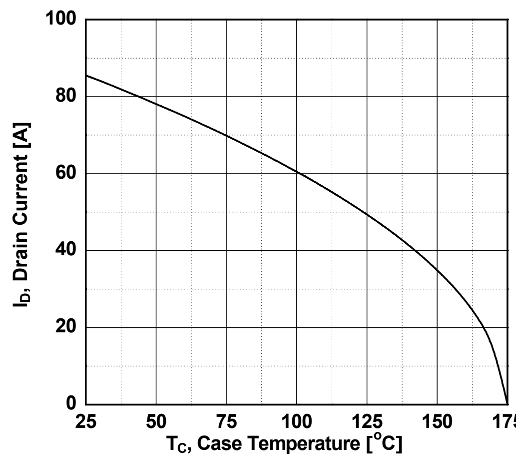
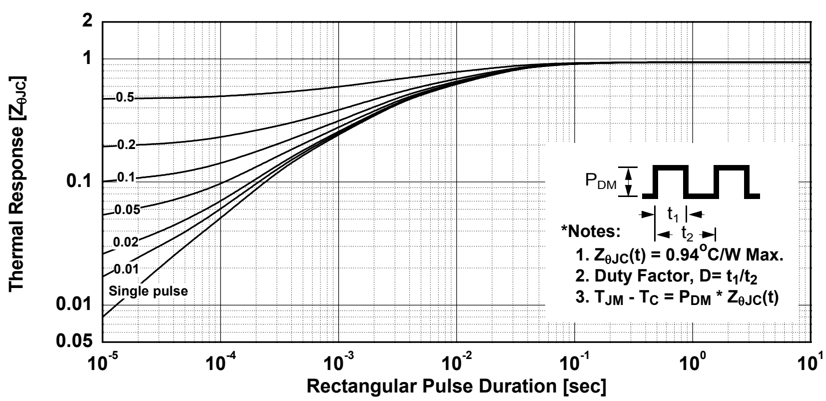
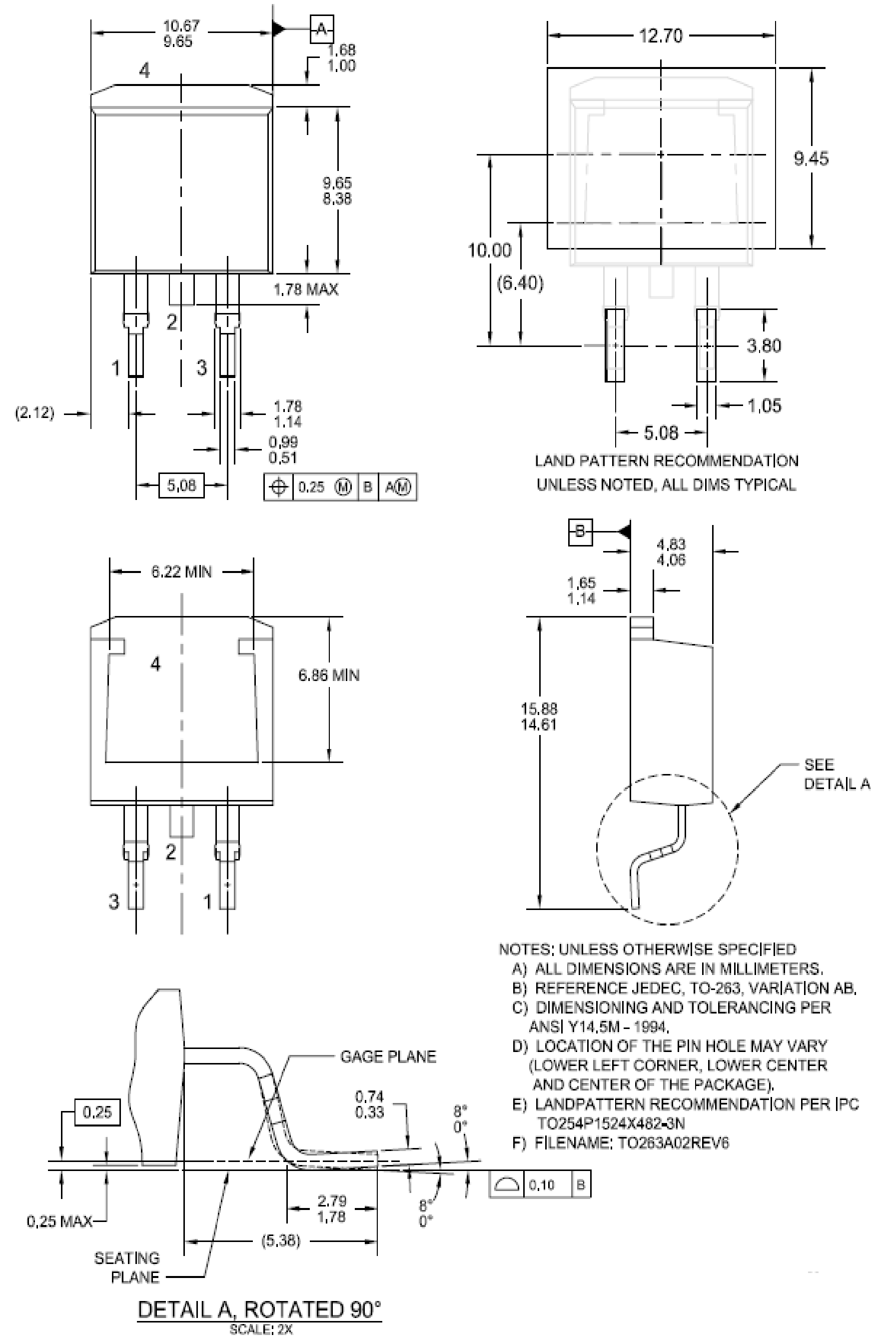


Figure 11. Transient Thermal Response Curve



Mechanical Dimensions

D2PAK



Dimensions in Millimeters
Dimensions in Millimeters

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